Beam Power Tube

CERAMIC-METAL SEALS
"ONE-PIECE" ELECTRODE DESIGN
CONDUCTION COOLED
COAXIAL-ELECTRODE STRUCTURE

52.5-WATTS CW INPUT 27-WATTS CW OUTPUT AT 400 Mc 15-WATTS CW OUTPUT AT 1200 Mc 3.2-WATTS CW OUTPUT AT 3000 Mc

UNIPOTENTIAL CATHODE

GENERAL DATA

| Electrical: | | | | |
|---|---|---------------------|----------------------------------|---|
| Heater, for Unipotential Voltage (AC or DC) Current at 12.6 volts. Minimum heating time . Mu-Factor, Grid No.2 to plate volts = 250, gri = 250, and plate ma. = Direct Interelectrode Ca Grid No.1 to plate Grid No.1 to cathode & Plate to cathode & Plate to cathode & No.2 Grid No.2 to plate Grid No.2 to plate Grid No.2 to cathode & Grid No.2 to cathode & | Grid No.1 for d-No.2 volts 35. pacitances: heater | 0.0 | 30 25 max5 04 max. 17 .2 18 max. | volts amp sec upf upf upf upf upf upf |
| Mechanical: | | | | |
| Operating Position Maximum Overall Length . Greatest Diameter (See D Weight (Approx.) Terminal Connections (See G) — Grid-No.1— Terminal Contact Surface G2 — Grid-No.2— Terminal Contact Surface H — Heater— Terminal Contact Surface H — Heater— Terminal Contact Surface H — Heater— Terminal Contact Surface Unification Surface | imensional Out | line) Outline) | | 0.5 oz |
| Thermal: Terminal Temperature (Plagrid No.1, cathode, and Cooling, Conduction: | te, grid No.2, d heater) | | 250 max. | oC |
| The plate terminal mus temperature device (he plate terminal to the s | at sink—solid pecified maxim | orliqui um value | d) to lir | nit the |

grid-No.2, grid-No.1, cathode, and heater terminals may also require coupling to the heat sink to limit their respective terminal temperature to the specified maximum value of 250° C.

RF PQWER AMPLIFIER & OSCILLATOR — Class C Telegraphy and

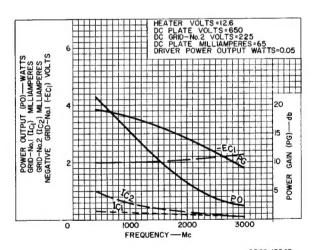
RF POWER AMPLIFIER - Class C FM Telephony

Maximum CCSC Ratings, Absolute-Maximum Values:

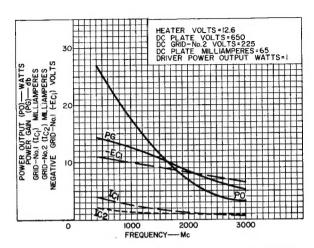
| DC PLATE VOLTAGE | | | | | | 750 | max. | volts |
|-----------------------|--|--|--|--|--|------|------|-------|
| | | | | | | | | |
| DC GRID-No.2 VOLTAGE. | | | | | | | | |
| DC GRID-No.1 VOLTAGE. | | | | | | -100 | max. | volts |
| DC PLATE CURRENT | | | | | | 70 | max. | ma |
| DC GRID-No.1 CURRENT. | | | | | | | | |
| PLATE INPUT | | | | | | | | |
| | | | | | | | | |
| GRID-No.2 INPUT | | | | | | 2 | max. | watts |
| DIATE DISSIDATION | | | | | | d | | |

Typical CCS Operation in Cathode-Drive Circuit:

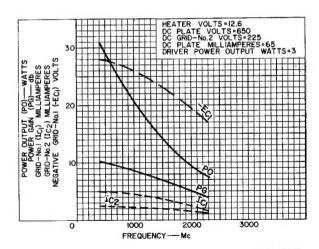
Shown Graphically in the following three Charts 92CS-10945, -10944, and -10942



92CS-10945



92CS-I0944



9205-10942

PLATE-MODULATED RF POWER AMPLIFIER -- Class C Telephony

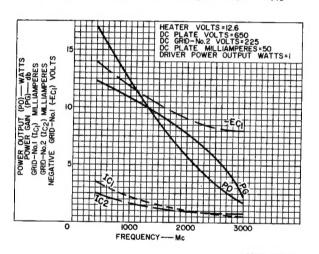
Carrier conditions per tube for use with a maximum modulation factor of 1

Maximum CCSc Ratings, Absolute-Naximum Values:

| DC PLATE VOLTAGE | | | | | | | | | | | | 750 | max. | volts |
|-----------------------|---|---|---|---|---|---|---|---|---|---|---|----------------|------|-------|
| DC GRID-No.2 VOLTAGE. | | | | , | | | | | | | | 250 | may. | volts |
| DC GRID-No.1 VOLTAGE. | | | | | | • | | | | | | -100 | max. | volts |
| DC PLATE CURRENT | • | • | | ٠ | • | • | ٠ | | | | | 60 | max. | ma |
| DC GRID-No.1 CURRENT. | • | ٠ | ٠ | • | • | ٠ | • | • | - | | ٠ | 15 | max. | ma |
| PLATE INPUT | • | ٠ | • | • | ٠ | ٠ | ٠ | ٠ | • | ٠ | ٠ | 45 | max. | watts |
| GRID-No.2 INPUT | • | • | • | • | • | ٠ | • | • | • | ٠ | • | ² d | max. | watts |

Typical CCS Operation in Cathode-Drive Circuit:

Shown Graphically in the following Chart 92CS-10943



92CS-10943

AF POWER AMPLIFIER & MODULATOR

and LINEAR RF POWER AMPLIFIER

Single-Sideband Suppressed-Carrier Service

Maximum CCSc Ratings, Absolute-Maximum Values:

| DC PLATE VOLTAGE | • | ٠ | | ٠ | ٠ | • | /50 max. volts |
|------------------------------|----|---|---|---|---|---|------------------|
| DC GRID-No.2 VOLTAGE | | | | - | | | 250 max. volts |
| MAXSIGNAL DC PLATE CURRENT® | | | | | | | 70 max. ma |
| MAXSIGNAL DC GRID-No.1 CURRE | NT | | | | | | 15 max. ma |
| MAXSIGNAL PLATE INPUT | | | | | | | 52.5 max. watts |
| | | | - | - | - | • | or to make makes |

30000 max. f

ohms

| MAXSIGNAL GRID-N PLATE DISSIPATION® | 0.2 | 1N | PUT | • | : | : | : | | : | | : | . ² d | max. | watts |
|---|------|-----|-----|----|-----|-----|-----|----|-----|----|---|------------------------|----------------------|-------------------|
| RF POWE | R AM | IPL | IFI | ER | _ | . (| 18 | sa | В | 1 | e | ephon | 1 | |
| Maximum CCS ^c Ratin | gs, | Ab | sol | ut | e l | las | cin | ш | ı 1 | ai | u | es: | | |
| DC PLATE VOLTAGE. DC GRID-No.2 VOLTA DC PLATE CURRENT. DC GRID-No.1 CURRE PLATE INPUT . GRID-No.2 INPUT . PLATE DISSIPATION | GE. | | | | | : | | : | : | : | | 250 35 8 52.5 | max. max. max. | volts ma ma |
| Maximum Circuit Va | | | and | :e | | | | | | | | | | |

- Because the cathode is subjected to considerable back bombardment as the frequency is increased with resultant increase in temperature, the heater voltage should be reduced depending on operating conditions and frequency to prevent overheating the cathode and resultant short life.
- b Measured with special shield adapter.

- Continuous Commercial Service.
- d Maximum plate dissipation is a function of the maximum plate input, efficiency of the class of service, and the effectiveness of the cooling system. See Cooling, Conduction under General Data, and also Cooling Considerations.
- Averaged over any audio-frequency cycle of sine-wave form for AP Power Amplifier & Modulator Service.
- f

 If this value is insufficient to provide adequate bias, the additional required bias must be supplied by a cathode resistor or fixed supply.

CHARACTERISTICS RANGE VALUES FOR EQUIPMENT DESIGN

| *************************************** | | | | |
|---|------|------|-------|------------|
| | Note | Min. | Max. | |
| Heater Current | 1 | 0.44 | 0.54 | amp |
| Direct Interelectrode Capacitances: | | | 0 005 | |
| Grid No.1 to plate | 2 | - | 0.025 | μμf |
| Grid No.1 to cathode & heater | 2 | 8.5 | 10.3 | $\mu\mu$ f |
| Plate to cathode & heater | 2 | _ | 0.004 | μμf |
| Grid No.1 to grid No.2 | 2 | 14 | 20.6 | $\mu\mu$ f |
| Grid No.2 to plate | 2 | 2.1 | 2.5 | μμt |
| Grid No.2 to cathode & heater | 2 | _ | 0.18 | μμιf |
| Grid-No.1 Voltage | 1,3 | -1 | -10 | volts |
| Grid-No.1 Cutoff Voltage | 1,4 | - | -25 | volts |
| Grid-No.2 Current | 1,3 | -3 | 2 | ma |
| Positive Grid-No.1 Voltage | 1,5 | 0 | 14 | volts |
| Transconductance | 1,6 | 7500 | - | μ mhos |

- Note 1: With 12.6 volts ac or dc on heater.
- Note 2: Measured with special shield adapter.
- Note 3: With dc plate voltage of 750 volts, dc grid-No.2 voltage of 250 volts, and dc grid-No.1 voltage adjusted to give a dc plate current of 35 ma.
- Note 4: With dc plate voltage of 750 volts, dc grid-No.2 voltage of 250 volts, and dc grid-No.1 voltage adjusted to give a dc plate current of 1 ma.

- Note 5: With dc plate voltage of 300 volts, dc grid-No.2 voltage of 250 volts, and dc grid-No.1 voltage of -100 volts. Rectangular pulses, pulse duration of 4500 to 5000 microseconds and pulse-repetition frequency of 10 to 12 pps. The positive-pulse grid-No.1 voltage is adjusted to give a plate current of 300 ma. at leading edge of pulse.
- Note 6: With dc plate voltage of 300 volts, dc grid-No.2 voltage of 150 volts, dc grid-No.1 voltage adjusted to give a dc plate current of 35 ma.

COOLING CONSIDERATIONS

The conduction-cooling system consists, in general, of a constant-temperature device (heat sink) and suitable heat-flow path (coupling) between the heat sink and tube. Careful consideration should be given to the design of a heat-flow path through a coupling device having high thermal conductivity.

Thermal conductivity may be calculated from the equation:

$$K = \frac{W}{A \cdot \frac{(T_2 - T_1)}{T_2}} \tag{1}$$

where:

K = thermal conductivity of the material

W = power transfer in watts

A = area measured at right angles to the direction of the flow of heat in square inches

 $T_1, T_2 = temperature in degrees Centigrade of planes or surfaces under consideration$

E = length of heat path in inches through coupling material to produce temperature gradient

 ${\bf 9}$ Thermal conductivity is defined as the time rate of transfer of heat by conduction, through unit thickness, across unit area for unit difference of temperature. It is measured in watts per square inch for a thickness of one inch and a difference of temperature of 10 C.

For a given system Equation (|) must be integrated to consider changes in area (A) dependent on the coupling configuration and changes in thermal conductivity (K) dependent on various coupling materials and interfaces. Equation (1) may now be reduced to the following:

$$\kappa_{S} = \frac{W_{P}}{T_{2} - T_{1}} \tag{2}$$

where:

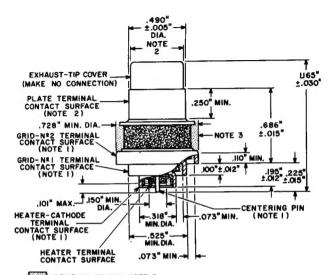
 K_{ς} = thermal conductance of the system

W_p = maximum permissible plate dissipation in watts

 T_2 = temperature in degrees Centigrade at tube terminal

T, = temperature in degrees Centigrade of heat sink





STIPPLED REGION NOTE 3

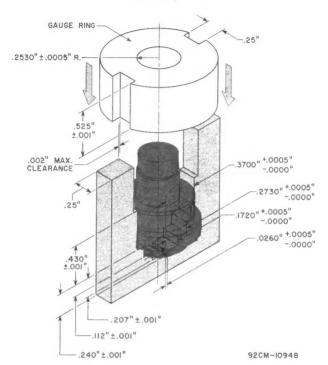
92CM-10939RI

NOTE 1: WITH THE CYLINDRICAL SURFACES OF THE GRID-No.2 TERMINAL, GRID-No.1 TERMINAL, HEATER-CATHODE TERMINAL, AND CENTERING PIN CLEAN, SMOOTH, AND FREE OF BURRS, THE TUBE WILL ENTER A GAUGE AS SHOWN IN SKETCH G1.

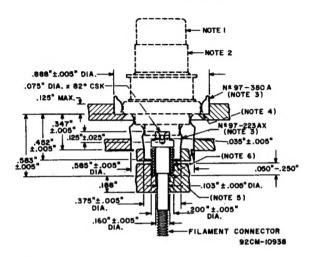
NOTE 2: WITH THE TUBE SEATED IN GAUGE AND WITH THE PLATE TERMINAL CLEAN, SMOOTH, AND FREE OF BURRS, THE GAUGE RING WILL SLIP OVER PLATE TERMINAL SHOWN IN SKETCH G1 AND NOT EXTEND ABOVE GAUGE. THE TUBE WILL ROTATE 360° FREELY AND WILL NOT EXTEND ABOVE GAUGE RING.

NOTE 3: KEEP ALL STIPPLED REGIONS CLEAR. DO NOT ALLOW CONTACTS OR CIRCUIT COMPONENTS TO PROTRUDE INTO THESE ANNULAR VOLUMES.





SUGGESTED MOUNTING ARRANGEMENT & LAYOUT OF ASSOCIATED CONTACTS



NOTE 1: MAKE NO CONNECTION.

NOTE 2: IF A CLAMP IS USED, IT MUST BE ADJUSTABLE IN A PLANE NORMAL TO THE MAJOR TUBE AXIS TO COMPENSATE FOR VARIATIONS IN CONCENTRICITY BETWEEN THE PLATE TERMINAL AND THE REMAINING CONTACT TERMINALS.

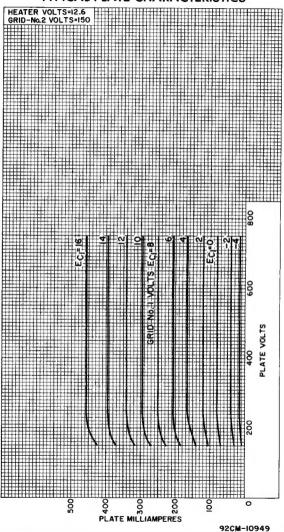
NOTE 3: MADE BY INSTRUMENTS SPECIALTIES COMPANY, LITTLE FALLS. NEW JERSEY.

NOTE 4: SEAT TUBE SUCH THAT GRID-No.2 TERMINAL EDGE MAKES A POSITIVE STOP ON SHOULDER.

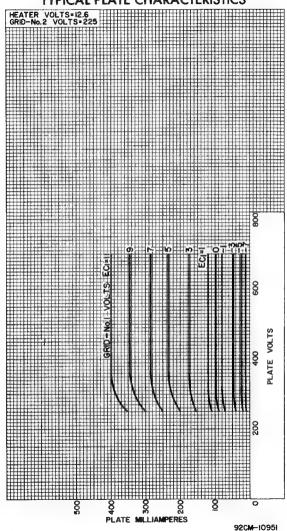
NOTE 5: SPRING IS 0.600 INCH IN LENGTH AND 30 TURNS PER INCH OF 0.015-INCH-DIAMETER STEEL MUSIC WIRE.

NOTE 6: FINGER STOCK TO SEAT ON 0.013-INCH LIP.

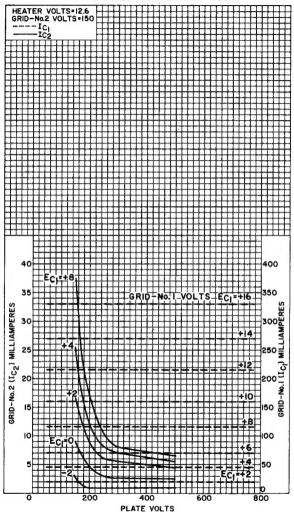
TYPICAL PLATE CHARACTERISTICS



TYPICAL PLATE CHARACTERISTICS

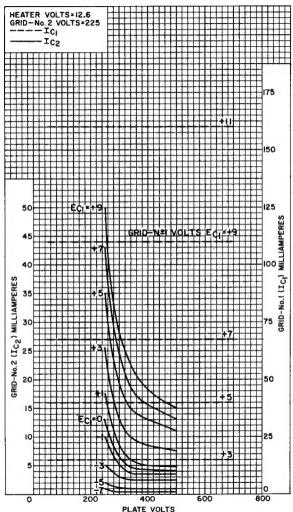


TYPICAL CHARACTERISTICS

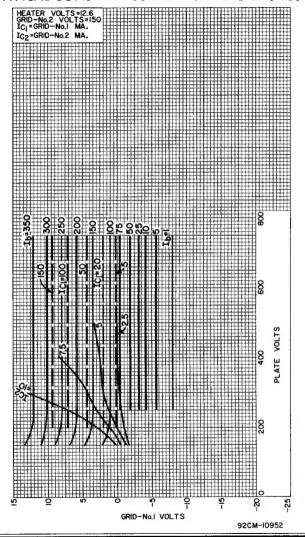


92CM-10950

TYPICAL CHARACTERISTICS



TYPICAL CONSTANT-CURRENT CHARACTERISTICS



TYPICAL CONSTANT-CURRENT CHARACTERISTICS

